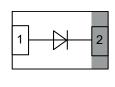


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## Vishay Semiconductors

# Small Signal Switching Diode with T<sub>J</sub> max. = 175 °C





#### **LINKS TO ADDITIONAL RESOURCES**







#### **MECHANICAL DATA**

Case: DFN1006-2A Weight: 0.83 mg

Molding compound flammability rating: UL 94 V-0 Terminals: high temperature soldering guaranteed:

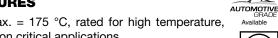
Peak temperature max. 260 °C Packaging codes / options: 08/10K per 7" reel (8 mm tape)

#### **FEATURES**

- T<sub>i</sub> max. = 175 °C, rated for high temperature, mission critical applications
- · Fast switching diode
- Leadless ultra small DFN1006-2A package  $(1 \text{ mm} \times 0.6 \text{ mm} \times 0.45 \text{ mm})$
- Power dissipation better than SOT-23
- Surface-mounted device (SMD) plastic package with visible and sidewall plated / wettable flanks
- Soldering can be checked by standard visual inspection. No X-ray inspection necessary to meet automotive AOI requirements



• Material categorization: for definitions of compliance please see www.vishay.com/doc?99912









GREEN (5-2008)

PARTS TABLE						
PART	ORDERING CODE	AEC-Q101 QUALIFIED	CIRCUIT CONFIGURATION	TYPE MARKING	REMARKS	
BAS16LTH	BAS16LTH-G3-08	no	Cinalo	GD	Tana and roal	
	BAS16LTH-HG3-08	yes	Single	GD GD	Tape and reel	

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified)					
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT	
Reverse voltage		V <sub>R</sub>	100	V	
Forward current on FR-4 board with recommended soldering footprint		I <sub>F</sub>	250	mA	
	t <sub>p</sub> = 1 μs		9	А	
Non repetitive forward current (1)	t <sub>p</sub> = 1 ms	I <sub>FSM</sub>	1.7		
	t <sub>p</sub> = 1 s		0.5		
Repetitive peak forward current	itive peak forward current $T_L = 100  ^{\circ}\text{C},  t_p = \leq 1  \text{ms},  D = 0.05$		500	mA	
Power dissipation	on FR-4 board with recommended soldering footprint	В	350	mW	
rower dissipation	R <sub>thJL</sub> = 100 K/W	P <sub>tot</sub>	1500	mW	

#### Note

(1) Square wave, T<sub>J</sub> = 25 °C prior to surge

THERMAL CHARACTERISTICS (T <sub>amb</sub> = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT		
Thermal resistance junction to ambient air	according to JEDEC® 51-3 on FR-4 board with recommended soldering footprint	R <sub>thJA</sub>	420	K/W		
Thermal resistance junction to lead		R <sub>thJL</sub>	100	K/W		
Maximum junction temperature		T <sub>J max.</sub>	175	°C		
Storage temperature range		T <sub>stg</sub>	-55 to +175	°C		
Operating temperature range		T <sub>op</sub>	-55 to +175	°C		



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<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL TYP.		MAX.	UNIT	
	I <sub>F</sub> = 150 mA			1.250	V	
Forward voltage	I <sub>F</sub> = 50 mA	V <sub>F</sub>		1.0	V	
Forward voltage	I <sub>F</sub> = 10 mA	VF		0.86	V	
	I <sub>F</sub> = 1 mA			0.715	V	
	V <sub>R</sub> = 80 V	I <sub>R</sub>		500	nA	
Lookaga augrapt	V <sub>R</sub> = 80 V, T <sub>J</sub> = 150 °C	I <sub>R</sub>		100	μΑ	
Leakage current	V <sub>R</sub> = 80 V, T <sub>J</sub> = 175 °C	I <sub>R</sub>		550	μΑ	
	V <sub>R</sub> = 100 V	I <sub>R</sub>		1	μΑ	
Diode capacitance	$V_R = 0 V, f = 1 MHz$	C <sub>D</sub>	0.36	2	pF	
Reverse recovery time	$I_F = 10 \text{ mA}, I_R = 10 \text{ mA}, I_R = 1 \text{ mA}$	t <sub>rr</sub>		4	ns	

### TYPICAL CHARACTERISTICS (T<sub>amb</sub> = 25 °C, unless otherwise specified)

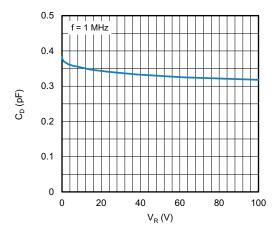


Fig. 1 - Typical Capacitance vs. Reverse Voltage

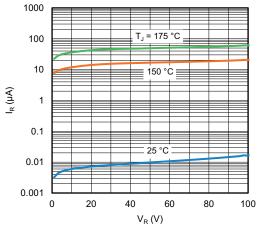


Fig. 3 - Typical Reverse Leakage Current vs. Reverse Voltage

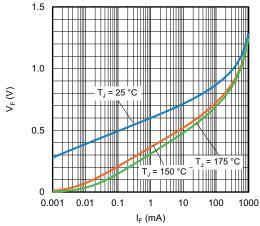


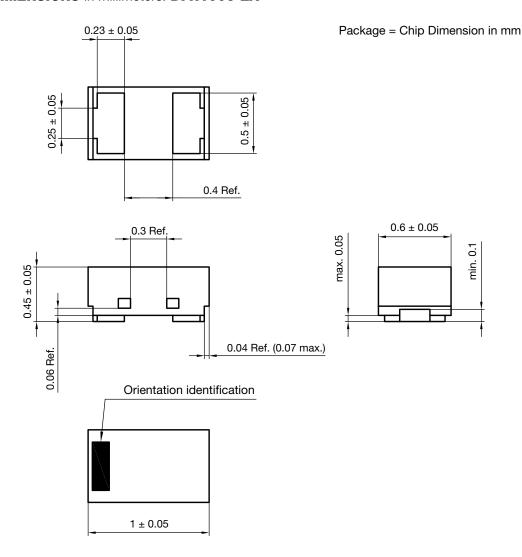
Fig. 2 - Typical Forward Voltage vs. Forward Current

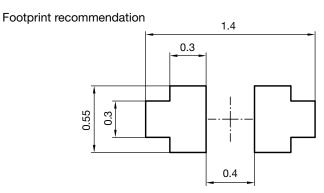




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### PACKAGE DIMENSIONS in millimeters: DFN1006-2A





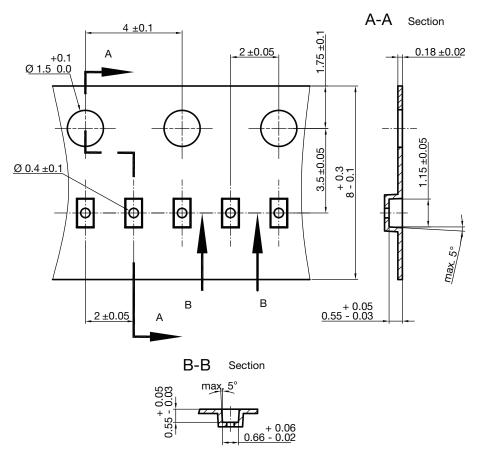
Document no.: S8-V-3906.04-059 (4) Created - Date: 11-Jul-2018 Rev.5 - Date: 17-Sep-2021

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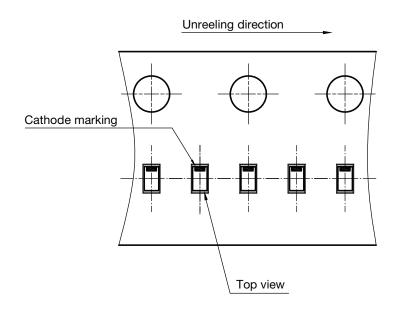
### **CARRIER TAPE DFN1006-2A**



S8-V-3906.04-063 (4) created 28.10.2019

surface resistance:  $10^5$  -  $10^{11} \frac{OHMS}{SQ}$ Cummulative tolerances of 10 sprocket holes is ± 0.2 mm

#### **ORIENTATION IN CARRIER TAPE DFN1006-2A**



S8-V-3906.04-064 (4) created 28.10.2019



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